CLAIMS

1. A method for producing a release film for forming a resin sheet, comprising the following steps:

an applying step of applying a release layer forming composition onto a surface layer A of a polyester film including the surface layer A,

the surface layer A being a layer substantially containing no inorganic particles,

the release layer forming composition containing a cationically curable polydimethylsiloxane (a);

a drying step of heating and drying the polyester film onto which the release layer forming composition is applied, the heating and drying including a first drying step and a second drying step, and a drying temperature T1 in the first drying step being higher than a drying temperature T2 in the second drying step; and

a photocuring step of irradiating the release layer forming composition with active energy rays after the drying step to cure the release layer forming composition.

2. The method for producing a release film for forming a resin sheet according to claim 1, wherein

the release layer forming composition contains an organic solvent having an SP value (δ) of 14 or more and 17

or less,

the release layer forming composition contains the organic solvent having an SP value (δ) of 14 or more and 17 or less in an amount of 10% by mass or more based on 100 parts by mass of a total weight of the release layer forming composition, and

an applied amount of the release layer forming composition in the applying step is 10 g/m^2 or less.

3. The method for producing a release film for forming a resin sheet according to claim 1 or 2, wherein the method is a method for producing a release film for producing a resin sheet containing an inorganic compound.

4. The method for producing a release film for forming a resin sheet according to claim 3, wherein the resin sheet containing an inorganic compound is a ceramic green sheet.

5. A method for producing a ceramic green sheet, further comprising forming a ceramic green sheet having a thickness of 0.2 μm or more and 1.0 μm or less in the method for producing a release film for forming a resin sheet according to claim 4.

6. The method for producing a release film for forming a resin sheet according to claim 3 or 4, comprising forming a resin sheet having a thickness of 0.2 μm or more and 1.0 μm or less.